

Specification for Approval

Date: 2022/07/29

Customer : _____

TAI-TECH P/N: **SWF1608RIV-SERIES-HD**

CUSTOMER P/N: _____

DESCRIPTION: _____

QUANTITY: _____ **pcs**

REMARK:		
Customer Approval Feedback		

西北臺慶科技股份有限公司
 TAI-TECH Advanced Electronics Co., Ltd
Headquarter:
 NO.1 YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG-MEI,
 TAO-YUAN HSIEN, TAIWAN, R.O.C.
 TEL: +886-3-4641148 FAX: +886-3-4643565
 http://www.tai-tech.com.tw
 E-mail: sales@tai-tech.com.tw

Office:
 深圳辦公室
 11BC, Building B Fortune Plaza, NO.7002, Shennan Avenue, Futian
 District Shenzhen
 TEL: +86-755-23972371 FAX: +86-755-23972340

臺慶精密電子(昆山)有限公司
 TAI-TECH ADVANCED ELECTRONICS(KUNSHAN) CO., LTD
 SHINWHA ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN,
 JIANG-SU, CHINA
 TEL: +86-512-57619396 FAX: +86-512-57619688
 E-mail: sales@tai-tech.cn

慶邦電子元器件(泗洪)有限公司
 TAIPAQ ELECTRONICS (SIHONG) CO., LTD
 Sihong development zone Suqian City, Jiangsu , CHINA.
 TEL: +86-527-88601191 FAX: +86-527-88601190
 E-mail: sales@taipaq.cn

Sales Dep.

APPROVED	CHECKED
管哲頌 Eric Kuan	劉瓊瑄 Aries Liu

R&D Center

APPROVED	CHECKED	DRAWN
楊祥忠 Mike Yang	徐鋒強 Gemini Hsu	何玉蓮 Anna Ho

Winding Type Chip Inductor

SWF1608RIV-SERIES-HD

ECN HISTORY LIST

REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN
1.0	22/07/29	新 發 行	楊祥忠	徐鋒強	何玉蓮
備 註					

Winding Type Chip Inductor

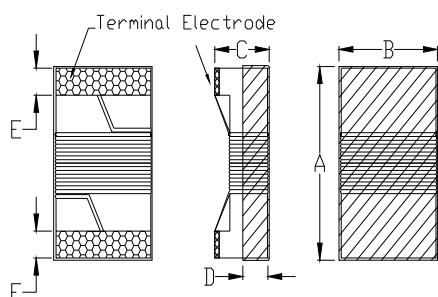
SWF1608RIV-SERIES-HD

1. Features

1. Ferrite core wire wound construction.
2. High Reliability due to wire wound type construction.
3. Small footprint as well as low profile.
4. 100% Lead (Pb) & Halogen-Free and RoHS compliant.
5. Operating temperature-55~+125°C (Including self - temperature rise)
6. These products provide low DC resistance and high current.
7. Precision inductance tolerance is available.
8. High reliability -Reliability comply with AEC-Q200
9. Application for DC power line.
 - Digital camera and other electronic equipment
 - Personal computers,Hard disk drives
 - Mobile Device / Handheld Device / LowProfile Device / Panel
 - xDSL modem and Cable modem



2. Dimensions



Size	A	B	C	D	E
SWF1608	1.60±0.20	1.00±0.20	1.00±0.10	0.60 ref.	0.35±0.10

Unit:mm

3. Part Numbering

SWF	1608	R	I	V	-	2R2	K	-	HD
A	B	C	D	E		F	G		H

A: Series
 B: Dimension L x W
 C: Control S/N
 D: Material I3C
 E: Category Code V=Vehicle
 F: Inductance 2R2=2.20uH
 G: Inductance Tolerance K=±10%, M=±20%
 H: Control S/N

4. Specification

TAI-TECH Part Number	Inductance (uH)	Tolerance	Test Frequency (Hz)	Q/MHz Typ.	SRF (MHz) Typ.	DCR (Ω) ±30%	Isat (mA) Typ.	Irms (mA) Typ.
SWF1608RIV-R10□-HD	0.10	K,M	0.5V/7.9M	13/7.9	1150	0.063	1700	1400
SWF1608RIV-R15□-HD	0.15	K,M	0.5V/7.9M	13/7.9	1050	0.074	1700	1300
SWF1608RIV-R27□-HD	0.27	K,M	0.5V/7.9M	13/7.9	1000	0.12	1400	1100
SWF1608RIV-R33□-HD	0.33	K,M	0.5V/7.9M	13/7.9	1100	0.13	1300	1000
SWF1608RIV-R47□-HD	0.47	K,M	0.5V/7.9M	13/7.9	900	0.18	1100	900
SWF1608RIV-R56□-HD	0.56	K,M	0.5V/7.9M	13/7.9	630	0.20	1100	800

TAI-TECH Part Number	Inductance (uH)	Tolerance	Test Frequency (Hz)	Q/MHz Typ.	SRF (MHz) Typ.	DCR (Ω) $\pm 30\%$	Isat (mA) Typ.	Irms (mA) Typ.
SWF1608RIV-R68□-HD	0.68	K,M	0.5V/7.9M	13/7.9	510	0.22	900	750
SWF1608RIV-1R0□-HD	1.0	K,M	0.5V/7.9M	16/7.9	390	0.32	860	700
SWF1608RIV-1R5□-HD	1.5	K,M	0.5V/7.9M	16/7.9	160	0.40	720	600
SWF1608RIV-2R2□-HD	2.2	K,M	0.5V/7.9M	16/7.9	103	0.56	600	580
SWF1608RIV-3R3□-HD	3.3	K,M	0.5V/7.9M	16/7.9	66	0.70	500	500
SWF1608RIV-4R7□-HD	4.7	K,M	0.5V/7.9M	16/7.9	51	0.97	400	420
SWF1608RIV-5R6□-HD	5.6	K,M	0.5V/7.9M	16/7.9	47	1.10	380	380
SWF1608RIV-6R8□-HD	6.8	K,M	0.5V/7.9M	16/7.9	43	1.50	340	340
SWF1608RIV-8R2□-HD	8.2	K,M	0.5V/7.9M	16/7.9	40	1.68	300	300
SWF1608RIV-100□-HD	10	K,M	0.5V/2.5M	14/2.5	36	1.85	280	280
SWF1608RIV-150□-HD	15	K,M	0.5V/2.5M	14/2.5	29	2.60	240	240
SWF1608RIV-180□-HD	18	K,M	0.5V/2.5M	14/2.5	28	2.90	220	220
SWF1608RIV-220□-HD	22	K,M	0.5V/2.5M	14/2.5	24	3.61	200	200

Note:

Measurement board data

Material : FR4

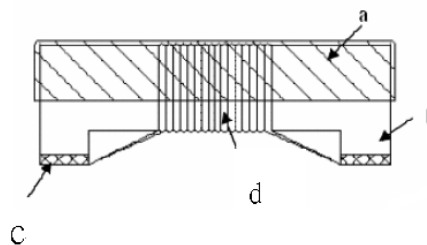
Board dimensions : 100 X 50 X 1.6t mm

Pattern dimensions: 45 X 30 mm (Double side board)

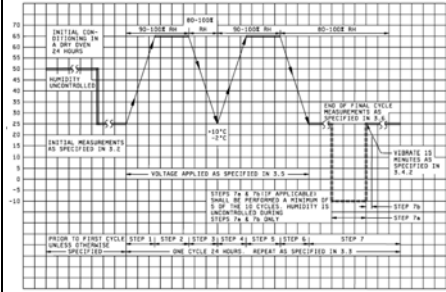
Pattern thickness : 50 μm

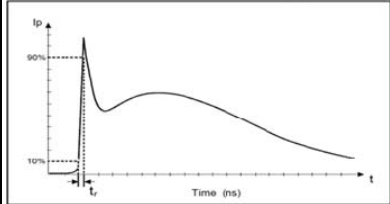
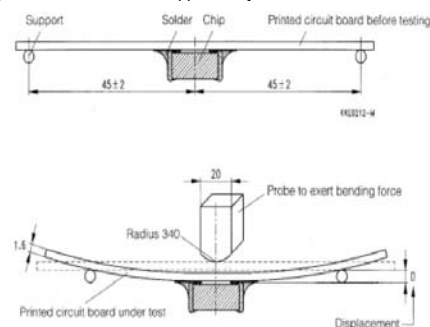
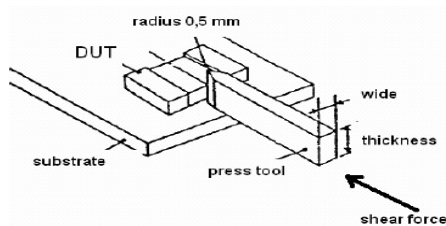
5. Materials

No.	Description	Specification
a.	Upper Plate	UV Glue
b.	Core	Ferrite Core
c.	Termination	Ag/Ni/Sn
d.	Wire	Enameled Copper Wire



6. Reliability and Test Condition

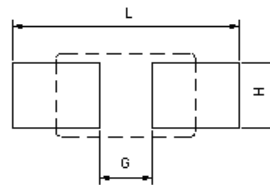
Item	Performance	Test Condition															
Operating temperature	-55~+125°C (Including self - temperature rise)																
Storage temperature	-55+125°C (on board)																
Electrical Performance Test																	
Inductance L	Refer to standard electrical characteristic list	Agilent E4991A , Keysight E4991B ,Keysight 4980AL															
Q		Agilent-4287, Agilent-4285															
SRF		Agilent E4991A , Keysight E4991B															
DC Resistance		Agilent-34420A Agilent-4338B															
ISAT		Applied the current to coils, the inductance change shall be less than 20% to initial value.															
IRMS	$\Delta T \leq 40^\circ C$	Heat Rated Current (I _{rms}) will cause the coil temperature rise ΔT (°C) without core loss. 1.Applied the allowed DC current. 2.Temperature measured by digital surface thermometer															
Reliability Test																	
High Temperature Exposure(Storage) AEC-Q200	Appearance : No damage. Inductance : within±10% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles Temperature : 125±2°C Duration : 1000hrs Min. Measured at room temperature after placing for 24±4 hrs.															
Temperature Cycling AEC-Q200		Preconditioning: Run through IR reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles Condition for 1 cycle Step1 : -55±2°C 30min Min. Step2 : 125±2°C transition time 1min MAX. Step3 : 125±2°C 30min Min. Step4 : Low temp. Transition time 1min MAX. Number of cycles : 1000 Measured at room temperature after placing for 24±4 hrs.															
Moisture Resistance (AEC-Q200)		t=24 hours/cycle. Note: Steps 7a & 7b Unpowered. 															
Biased Humidity (AEC-Q200)		Preconditioning: Run through IR reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles Humidity : 85±3% R.H, Temperature : 85°C±2°C Duration: 1000hrs Min. Measured at room temperature after placing for24±4hrs															
High Temperature Operational Life (AEC-Q200)		Preconditioning: Run through IR reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles Temperature : 125±2°C Duration : 1000hrs Min. with 100% rated current. Measured at room temperature after placing for24±4hrs															
External Visual		Appearance : No damage.	Inspect device construction, marking and workmanship. Electrical Test not required.														
Physical Dimension		According to the product specification size measurement	According to the product specification size measurement														
Resistance to Solvents	Appearance : No damage.	Add aqueous wash chemical - OKEM clean or equivalent.															
Mechanical Shock	Appearance : No damage. Inductance : within±10% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value	<table border="1"> <thead> <tr> <th>Type</th> <th>Peak value (g's)</th> <th>Normal duration (D) (ms)</th> <th>Wave form</th> <th>Velocity change (Vi)ft/sec</th> </tr> </thead> <tbody> <tr> <td>SMD</td> <td>100</td> <td>6</td> <td>Half-sine</td> <td>12.3</td> </tr> <tr> <td>Lead</td> <td>100</td> <td>6</td> <td>Half-sine</td> <td>12.3</td> </tr> </tbody> </table> 3 shocks in each direction along 3 perpendicular axes. (18 shocks).	Type	Peak value (g's)	Normal duration (D) (ms)	Wave form	Velocity change (Vi)ft/sec	SMD	100	6	Half-sine	12.3	Lead	100	6	Half-sine	12.3
Type	Peak value (g's)	Normal duration (D) (ms)	Wave form	Velocity change (Vi)ft/sec													
SMD	100	6	Half-sine	12.3													
Lead	100	6	Half-sine	12.3													

Item	Performance	Test Condition								
Vibration		IPC/JEDEC J-STD-020E Classification Reflow Profiles Oscillation Frequency:10Hz~2KHz~10Hz for 20 minute Equipment : Vibration checker Total Amplitude:5g Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations) .								
Resistance to Soldering Heat		Test condition : <table border="1"> <thead> <tr> <th>Temperature(°C)</th> <th>Time(s)</th> <th>Temperature ramp/immersion and emersion rate</th> <th>Number of heat cycles</th> </tr> </thead> <tbody> <tr> <td>260 ±5 (solder temp)</td> <td>10 ±1</td> <td>25mm/s ±6 mm/s</td> <td>1</td> </tr> </tbody> </table>	Temperature(°C)	Time(s)	Temperature ramp/immersion and emersion rate	Number of heat cycles	260 ±5 (solder temp)	10 ±1	25mm/s ±6 mm/s	1
Temperature(°C)	Time(s)	Temperature ramp/immersion and emersion rate	Number of heat cycles							
260 ±5 (solder temp)	10 ±1	25mm/s ±6 mm/s	1							
Thermal shock (AEC-Q200)	Appearance : No damage. Inductance : within±10% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles Condition for 1 cycle Step1 : -55±2°C 15±1min Step2 : 125±2°C within 20Sec. Step3 : 125±2°C 15±1min Number of cycles : 300 Measured at room temperature after placing fo24±4hrs								
ESD	Appearance : No damage.	 Direct Contact and Air Discharge PASSIVE COMPONENT HBM ESD Discharge Waveform to a Coaxial Target Test method: AEC-Q200-002 Test mode : Contact Discharge Discharge level : 4 KV (Level: 2)								
Solderability	More than 95% of the terminal electrode should be covered with solder .	a. Method B, 4 hrs @155°C dry heat @235°C±5°C Testing Time :5 +0/-0.5 seconds b. Method D category 3. (8hours ± 15 min)@ 260°C±5°C Testing Time :30 +0/-0.5 seconds								
Electrical Characterization	Refer Specification for Approval	Summary to show Min, Max, Mean and Standard deviation.								
Flammability	Electrical Test not required.	V-0 or V-1 are acceptable.								
Board Flex	Appearance : No damage	Preconditioning: Run through IR reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles Place the 100mm X 40mm board into a fixture similar to the one shown in below Figure with the component facing down. The apparatus shall consist of mechanical means to apply a force which will bend the board (D) x = 2 mm minimum. The duration of the applied forces shall be 60 (+ 5) sec. The force is to be applied only once to the board. 								
Terminal Strength(SMD)	Appearance : No damage	AEC-Q200,TAI-TECH SPEC V10N 								

7. Soldering and Mounting

7-1. Recommended PC Board Pattern

Chip size							Land Patterns For Reflow Soldering		
Series	Type	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)	L(mm)	G(mm)	H(mm)
SWF	1608	1.60±0.2	1.0±0.2	1.0±0.1	0.60 ref	0.35±0.1	1.92	0.92	1.02



7-2. Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

7-2.1 IR Soldering Reflow:

Recommended temperature profiles for lead free re-flow soldering in Figure 1. Table 1.1&1.2 (J-STD-020E)

7-2.2 Soldering Iron:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. (Figure 2.)

- Preheat circuit and products to 150°C
- Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- 350°C tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 4~5sec.

Fig.1 IR Soldering Reflow

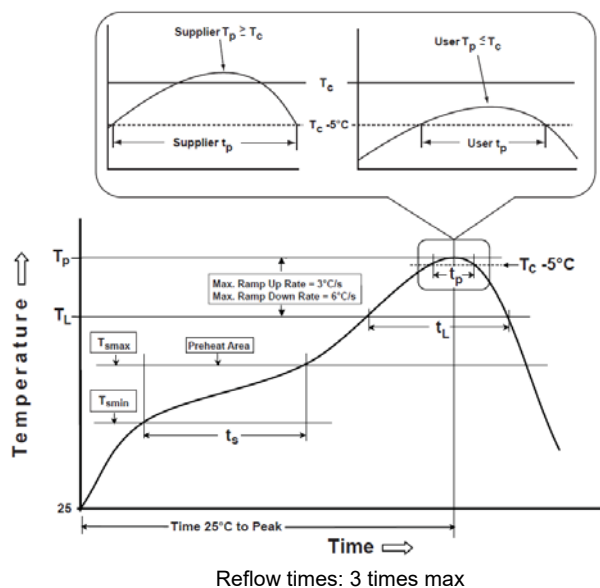


Fig.2 Iron soldering temperature profiles

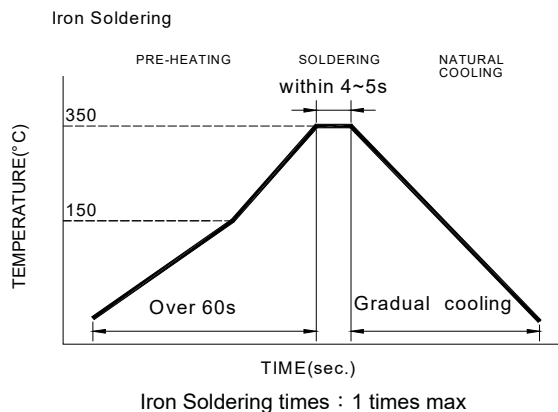


Table (1.1): Reflow Profiles

Profile Type:	Pb-Free Assembly
Preheat -Temperature Min(T_{smin}) -Temperature Max(T_{smax}) -Time(t_s)from(T_{smin} to T_{smax})	150°C 200°C 60-120seconds
Ramp-up rate(T_L to T_p)	3°C/second max.
Liquidus temperature(T_L) Time(t_L)maintained above T_L	217°C 60-150 seconds
Classification temperature(T_c)	See Table (1.2)
Time(t_p) at $T_c - 5^\circ\text{C}$ (T_p should be equal to or less than T_c .)	< 30 seconds
Ramp-down rate(T_p to T_L)	6°C /second max.
Time 25°C to peak temperature	8 minutes max.

T_p: maximum peak package body temperature, **T_c**: the classification temperature.

For user (customer) **T_p** should be equal to or less than **T_c**.

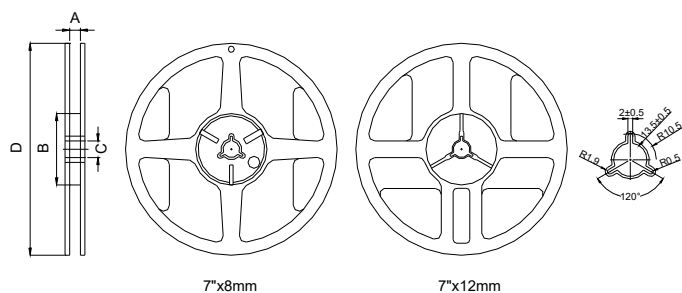
Table (1.2) Package Thickness/Volume and Classification Temperature (T_c)

	Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
PB-Free Assembly	<1.6mm	260°C	260°C	260°C
	1.6-2.5mm	260°C	250°C	245°C
	≥2.5mm	250°C	245°C	245°C

Reflow is referred to standard IPC/JEDEC J-STD-020E ◦

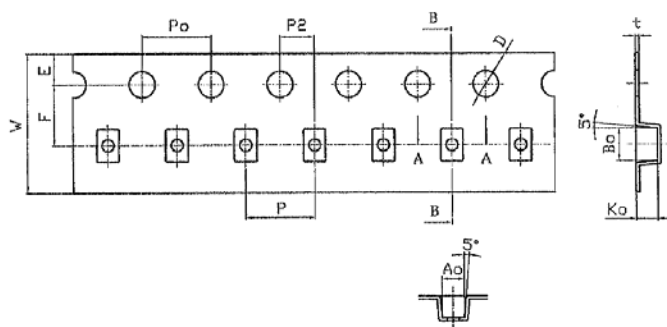
8. Packaging Information

8-1. Reel Dimension



Type	A(mm)	B(mm)	C(mm)	D(mm)
7"x8mm	9.0±0.5	60.0±2.0	13.5±0.5	178.0±2.0

8-2. Tape Dimension / 8mm(black anti-static electricity carrier tape)

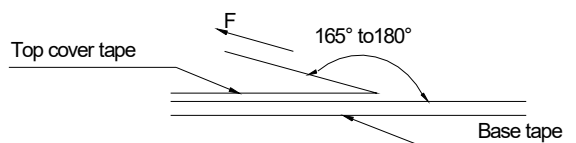


Series	W(mm)	P(mm)	E(mm)	F(mm)	P2(mm)	D(mm)	D1(mm)	Bo(mm)	Ao(mm)	Ko(mm)	Po(mm)	t(mm)
SWF1608	8.00±0.10	4.00±0.10	1.75±0.10	3.50±0.05	2.00±0.05	1.50+0.10-0.00	0.70±0.10	1.78±0.10	1.21±0.10	1.21±0.10	4.00±0.10	0.20±0.05

8-3. Packaging Quantity

SWF	1608
Chip / Reel	4000
Reel Size	7"x8mm

8-4. Tearing Off Force



The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min
5~35	45~85	860~1060	300

Application Notice

- Storage Conditions(component level)
 - To maintain the solderability of terminal electrodes:
 - TAI-TECH products meet IPC/JEDEC J-STD-020E standard-MSL, level 1.
 - Temperature and humidity conditions: Less than 40°C and 60% RH.
 - Recommended products should be used within 12 months form the time of delivery.
 - The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
 - Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
 - The use of tweezers or vacuum pick up is strongly recommended for individual components.
 - Bulk handling should ensure that abrasion and mechanical shock are minimized.



測試報告

Test Report

號碼(No.): ETR21805557 日期(Date): 02-Sep-2021

頁數(Page): 1 of 13

西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)

臺慶精密電子(昆山)有限公司 (TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO. LTD.)

慶邦電子元器件(泗洪)有限公司 (TAIPAQ ELECTRONICS (SI-HONG) CO., LTD.)

桃園市楊梅區幼獅工業區幼四路1號 (NO. 1, YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG-MEI, TAO-YUAN CITY, TAIWAN R. O. C.)

江蘇省昆山市鐘朗昆嘉高科技工業區郭澤路 (GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA)

中國·江蘇省·宿遷市·泗洪縣·經濟開發區杭州路南側·建設北路東側 (THE SOUTH HANGZHOU ROAD AND THE EAST JIANSHE ROAD · ECONOMIC DEVELOPMENT ZONE · SIHONG COUNTY · SUQIANCITY · JIANGSU PROVINCE · P,R · CHINA)


以下測試樣品係由申請廠商所提供及確認 (The following sample(s) was/were submitted and identified by/on behalf of the applicant as) :

樣品名稱(Sample Name) : WIREWOUND SERIES (FILM BACKING)
樣品型號(Style/Item No.) : SWF、SWC_F、PAS、WCM-L2NF、SWF-LF、SWFA、SWF(SWC)、ACMU、WCMU、WCM-F2SN、TTC SERIES

=====
收件日(Sample Receiving Date) : 26-Aug-2021
測試期間(Testing Period) : 26-Aug-2021 to 02-Sep-2021

測試需求(Test Requested) : 依據客戶要求進行測試·測試項目請參閱測試結果表格。(Testing item(s) is/are specified by client. Please refer to result table for testing item(s).)

測試結果(Test Results) : 請參閱下一頁 (Please refer to following pages.)


Troy Chang, Manager, Tel. [redacted]
Signed for and on behalf of
SGS TAIWAN LTD.
Chemical Laboratory - Taipei



PIN CODE: 46D15466

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測試報告

Test Report

號碼(No.): ETR21805557

日期(Date): 02-Sep-2021

頁數(Page): 2 of 13

西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)

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測試部位敘述 (Test Part Description)

No.1 : 整體混測 (MIXED ALL PARTS)

測試結果 (Test Results)

測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
鎘 (Cd) (Cadmium (Cd)) (CAS No.: 7440-43-9)	參考IEC 62321-5: 2013 · 以感應耦合電漿發射光譜儀分析 · (With reference to IEC 62321-5: 2013, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
鉛 (Pb) (Lead (Pb)) (CAS No.: 7439-92-1)		mg/kg	2	n.d.
汞 (Hg) (Mercury (Hg)) (CAS No.: 7439-97-6)	參考IEC 62321-4: 2013+ AMD1: 2017 · 以感應耦合電漿發射光譜儀分析 · (With reference to IEC 62321-4: 2013+ AMD1: 2017, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
六價鉻 Cr(VI) (Hexavalent Chromium Cr(VI)) (CAS No.: 18540-29-9)	參考IEC 62321-7-2: 2017 · 以紫外光-可見光分光光度計分析 · (With reference to IEC 62321-7-2: 2017, analysis was performed by UV-VIS.)	mg/kg	8	n.d.
一溴聯苯 (Monobromobiphenyl)	參考IEC 62321-6: 2015 · 以氣相層析儀/質譜儀分析 · (With reference to IEC 62321-6: 2015, analysis was performed by GC/MS.)	mg/kg	5	n.d.
二溴聯苯 (Dibromobiphenyl)		mg/kg	5	n.d.
三溴聯苯 (Tribromobiphenyl)		mg/kg	5	n.d.
四溴聯苯 (Tetrabromobiphenyl)		mg/kg	5	n.d.
五溴聯苯 (Pentabromobiphenyl)		mg/kg	5	n.d.
六溴聯苯 (Hexabromobiphenyl)		mg/kg	5	n.d.
七溴聯苯 (Heptabromobiphenyl)		mg/kg	5	n.d.
八溴聯苯 (Octabromobiphenyl)		mg/kg	5	n.d.
九溴聯苯 (Nonabromobiphenyl)		mg/kg	5	n.d.
十溴聯苯 (Decabromobiphenyl)		mg/kg	5	n.d.
多溴聯苯總和 (Sum of PBBs)		mg/kg	-	n.d.

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測試報告

Test Report

號碼(No.): ETR21805557 日期(Date): 02-Sep-2021

頁數(Page): 3 of 13

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
一溴聯苯醚 (Monobromodiphenyl ether)	參考IEC 62321-6: 2015 · 以氣相層析儀/質譜儀分析。(With reference to IEC 62321-6: 2015, analysis was performed by GC/MS.)	mg/kg	5	n.d.
二溴聯苯醚 (Dibromodiphenyl ether)		mg/kg	5	n.d.
三溴聯苯醚 (Tribromodiphenyl ether)		mg/kg	5	n.d.
四溴聯苯醚 (Tetrabromodiphenyl ether)		mg/kg	5	n.d.
五溴聯苯醚 (Pentabromodiphenyl ether)		mg/kg	5	n.d.
六溴聯苯醚 (Hexabromodiphenyl ether)		mg/kg	5	n.d.
七溴聯苯醚 (Heptabromodiphenyl ether)		mg/kg	5	n.d.
八溴聯苯醚 (Octabromodiphenyl ether)		mg/kg	5	n.d.
九溴聯苯醚 (Nonabromodiphenyl ether)		mg/kg	5	n.d.
十溴聯苯醚 (Decabromodiphenyl ether)		mg/kg	5	n.d.
多溴聯苯醚總和 (Sum of PBDEs)		mg/kg	-	n.d.
六溴環十二烷及所有主要被辨別出的異構物(HBCDD) (α- HBCDD, β- HBCDD, γ- HBCDD) (Hexabromocyclododecane (HBCDD) and all major diastereoisomers identified (α- HBCDD, β- HBCDD, γ- HBCDD)) (CAS No.: 25637-99-4, 3194-55-6 (134237-51-7, 134237-50-6, 134237-52-8))	參考IEC 62321: 2008 · 以氣相層析儀/質譜儀分析。(With reference to IEC 62321: 2008, analysis was performed by GC/MS.)	mg/kg	5	n.d.
氟 (F) (Fluorine (F)) (CAS No.: 14762-94-8)	參考BS EN 14582: 2016 · 以離子層析儀分析。(With reference to BS EN 14582: 2016, analysis was performed by IC.)	mg/kg	50	n.d.
氯 (Cl) (Chlorine (Cl)) (CAS No.: 22537-15-1)		mg/kg	50	n.d.
溴 (Br) (Bromine (Br)) (CAS No.: 10097-32-2)		mg/kg	50	n.d.
碘 (I) (Iodine (I)) (CAS No.: 14362-44-8)		mg/kg	50	n.d.

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測試報告

Test Report

號碼(No.): ETR21805557

日期(Date): 02-Sep-2021

頁數(Page): 4 of 13

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
鄰苯二甲酸丁苯甲酯 (BBP) (Butyl benzyl phthalate (BBP)) (CAS No.: 85-68-7)	參考IEC 62321-8: 2017 · 以氣相層析儀/質譜儀分析 · (With reference to IEC 62321-8: 2017, analysis was performed by GC/MS.)	mg/kg	50	n.d.
鄰苯二甲酸二丁酯 (DBP) (Dibutyl phthalate (DBP)) (CAS No.: 84-74-2)		mg/kg	50	n.d.
鄰苯二甲酸二(2-乙基己基)酯 (DEHP) (Di-(2-ethylhexyl) phthalate (DEHP)) (CAS No.: 117-81-7)		mg/kg	50	n.d.
鄰苯二甲酸二異丁酯 (DIBP) (Diisobutyl phthalate (DIBP)) (CAS No.: 84-69-5)		mg/kg	50	n.d.
鄰苯二甲酸二異癸酯 (DIDP) (Diisodecyl phthalate (DIDP)) (CAS No.: 26761-40-0, 68515-49-1)		mg/kg	50	n.d.
鄰苯二甲酸二異壬酯 (DINP) (Diisononyl phthalate (DINP)) (CAS No.: 28553-12-0, 68515-48-0)		mg/kg	50	n.d.
鄰苯二甲酸二正辛酯 (DNOP) (Di-n-octyl phthalate (DNOP)) (CAS No.: 117-84-0)		mg/kg	50	n.d.
鄰苯二甲酸二正戊酯 (DNPP) (Di-n-pentyl phthalate (DNPP)) (CAS No.: 131-18-0)		mg/kg	50	n.d.
鄰苯二甲酸二正己酯 (DNHP) (Di-n-hexyl phthalate (DNHP)) (CAS No.: 84-75-3)		mg/kg	50	n.d.

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測試報告

Test Report

號碼(No.): ETR21805557

日期(Date): 02-Sep-2021

頁數(Page): 5 of 13

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
聚氯乙烯 (Polyvinyl chloride) (PVC)	參考ASTM E1252: 2013 · 以傅立葉轉換紅外線光譜儀及焰色法分析。(With reference to ASTM E1252: 2013, analysis was performed by FT-IR and Flame Test.)	**	-	Negative
銻 (Sb) (Antimony (Sb)) (CAS No.: 7440-36-0)	參考US EPA 3052: 1996 · 以感應耦合電漿發射光譜儀分析。(With reference to US EPA 3052: 1996, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
鈹 (Be) (Beryllium (Be)) (CAS No.: 7440-41-7)	參考US EPA 3052: 1996 · 以感應耦合電漿發射光譜儀分析。(With reference to US EPA 3052: 1996, analysis was performed by ICP-OES.)	mg/kg	2	n.d.

備註(Note) :

1. mg/kg = ppm ; 0.1wt% = 1000ppm
2. MDL = Method Detection Limit (方法偵測極限值)
3. n.d. = Not Detected (未檢出) ; 小於MDL / Less than MDL
4. "-" = Not Regulated (無規格值)
5. **= Qualitative analysis (No Unit) 定性分析(無單位)
6. Negative = Undetectable 陰性(未偵測到); Positive = Detectable 陽性(已偵測到)
7. 樣品的測試是基於申請人要求混合測試 · 報告中的混合測試結果不代表其中個別單一材質的含量 ·

The sample(s) was/were analyzed on behalf of the applicant as mixing sample in one testing. The above result(s) was/were only given as the informality value.

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測試報告

Test Report

號碼(No.): ETR21805557

日期(Date): 02-Sep-2021

頁數(Page): 6 of 13

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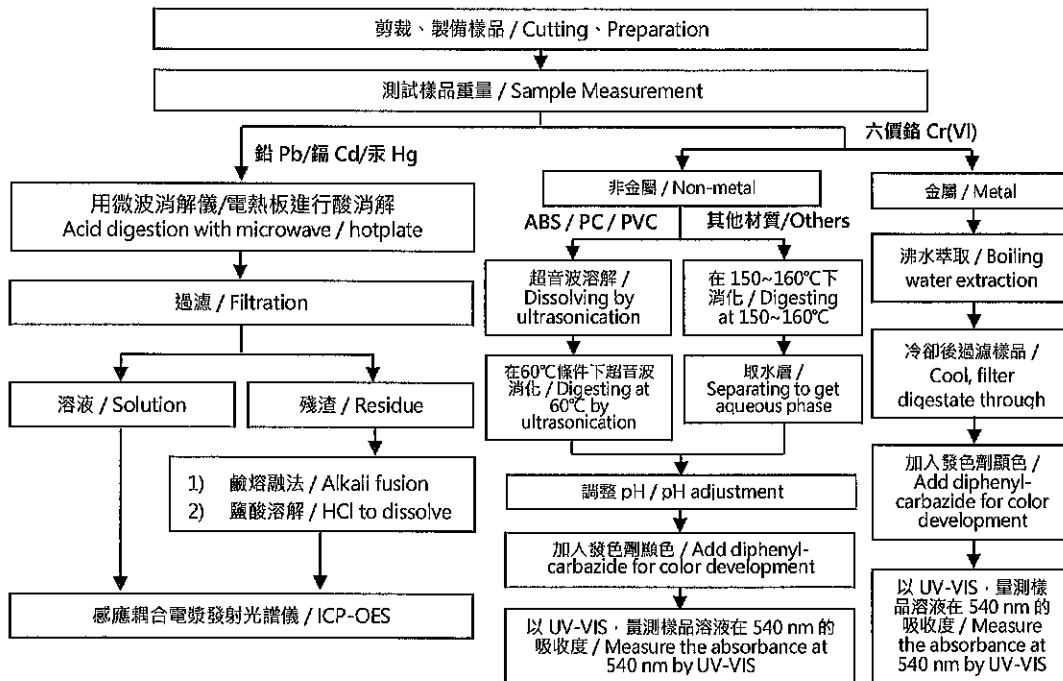
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重金屬流程圖 / Analytical flow chart of Heavy Metal

根據以下的流程圖之條件· 樣品已完全溶解· (六價鉻測試方法除外)

These samples were dissolved totally by pre-conditioning method according to below flow chart.

(Cr⁶⁺ test method excluded)



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頁數(Page): 7 of 13

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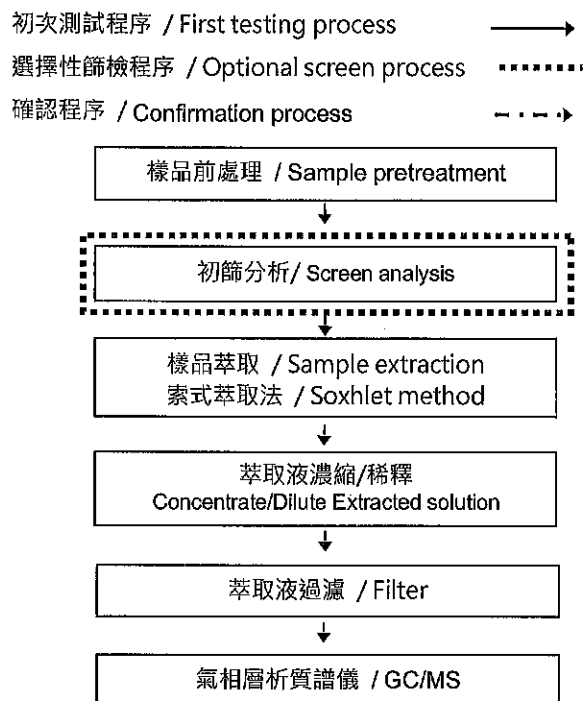
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多溴聯苯/多溴聯苯醌分析流程圖 / Analytical flow chart - PBBs/PBDEs



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頁數(Page): 8 of 13

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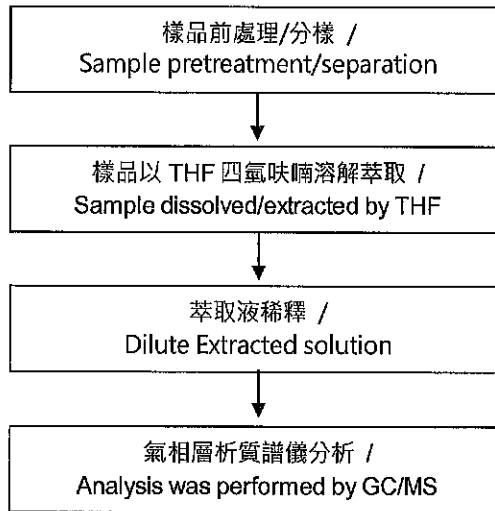
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可塑劑分析流程圖 / Analytical flow chart - Phthalate

【測試方法/Test method: IEC 62321-8】



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測試報告

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頁數(Page): 9 of 13

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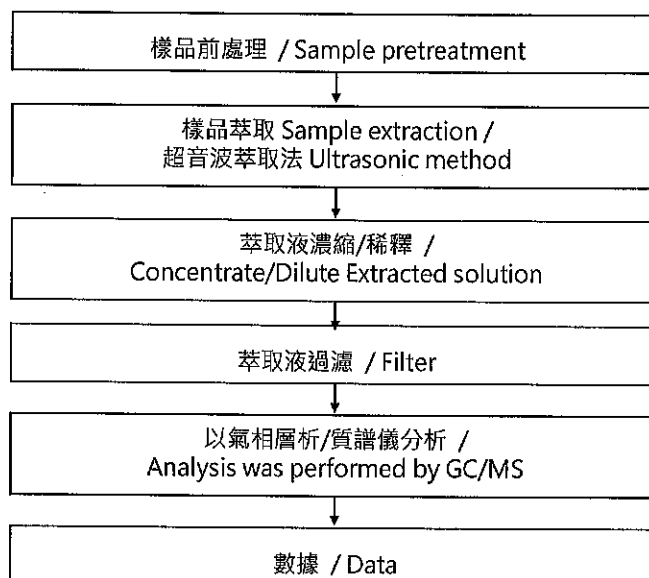
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六溴環十二烷分析流程圖 / Analytical flow chart - HBCDD



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測試報告

Test Report

號碼(No.): ETR21805557

日期(Date): 02-Sep-2021

頁數(Page): 10 of 13

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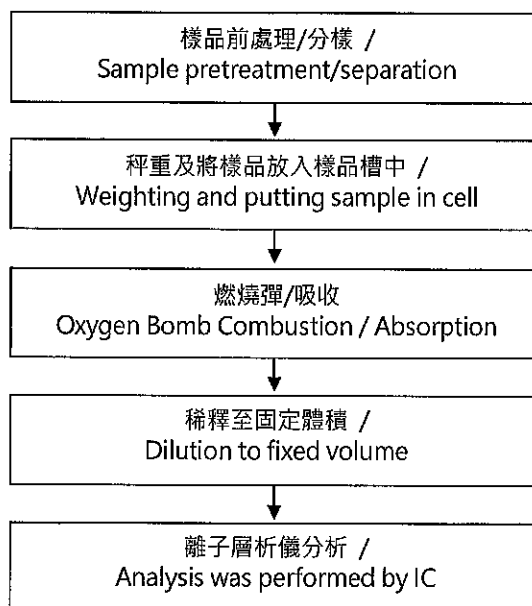
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鹵素分析流程圖 / Analytical flow chart - Halogen



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頁數(Page): 11 of 13

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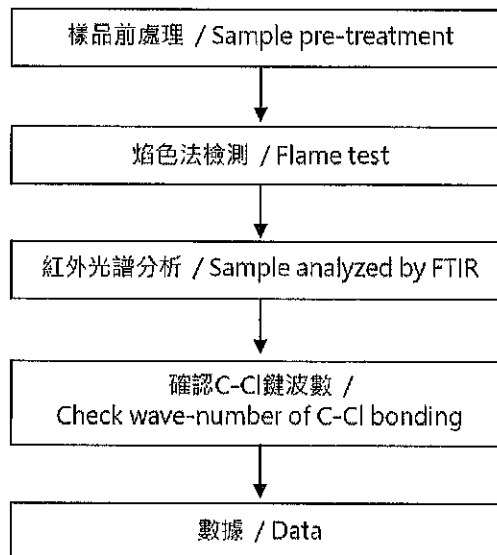
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聚氯乙烯物質判定分析流程圖 / Analysis flow chart - PVC



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頁數(Page): 12 of 13

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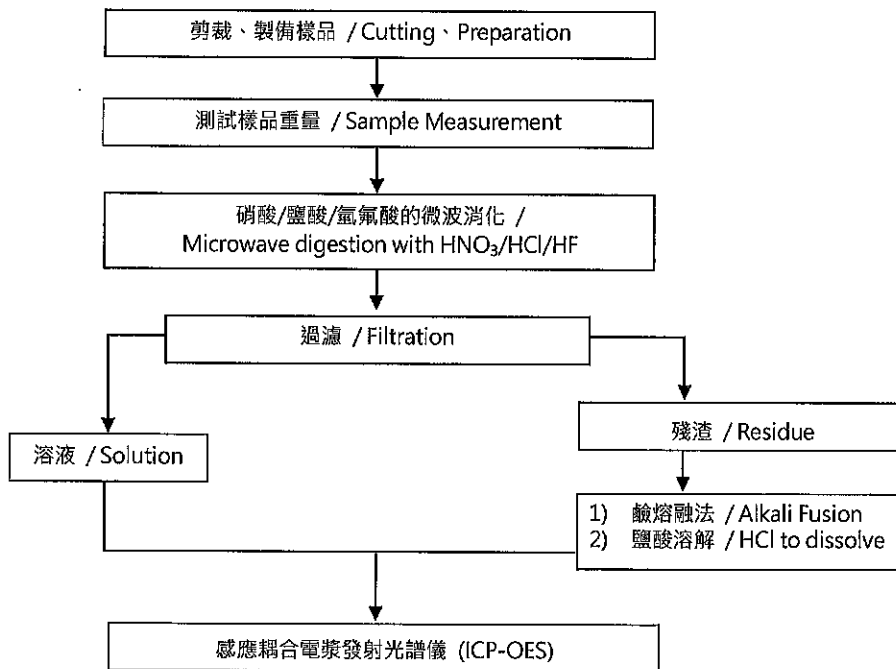
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元素(含重金屬)分析流程圖 / Analytical flow chart of Elements (Heavy metal included)

根據以下的流程圖之條件·樣品已完全溶解·

These samples were dissolved totally by pre-conditioning method according to below flow chart.

【參考方法/Reference method : US EPA 3051A · US EPA 3052】



* US EPA 3051A 方法未添加氫氟酸 / US EPA 3051A method does not add HF.

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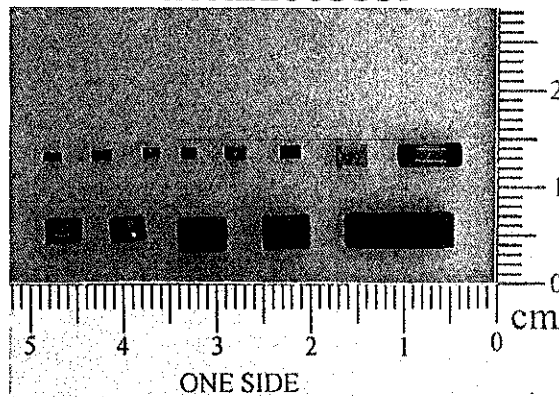
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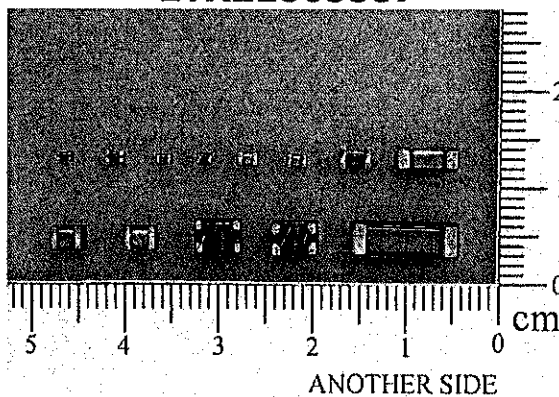
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* 照片中如有箭頭標示·則表示為實際檢測之樣品/部位.*
(The tested sample / part is marked by an arrow if it's shown on the photo.)

ETR21805557



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** 報告結尾 (End of Report) **

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